

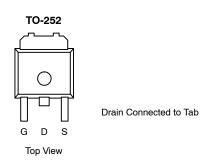
## NTD110N02RG-VB Datasheet

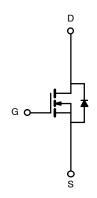
# N-Channel 20-V (D-S)175 $^{\circ}$ C MOSFET

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	(V) $r_{DS(on)}(\Omega)$				
20	0.0045 @ V <sub>GS</sub> = 4.5 V	100			
20	0.006 @ V <sub>GS</sub> = 2.5 V	90			

#### **FEATURES**

- Trench Power MOSFET
- 175°C Maximum Junction Temperature
- 100% R<sub>g</sub> Tested





N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^{\circ}C$ UNLESS OTHERWISE NOTED)						
Parameter		Symbol	Limit	Unit		
Drain-Source Voltage	V <sub>DS</sub>	20	.,			
Gate-Source Voltage		V <sub>GS</sub>	±15	\ \		
Continuous Pusis Comments	T <sub>C</sub> = 25°C		100			
Continuous Drain Current <sup>a</sup>	T <sub>C</sub> = 100°C	l <sub>D</sub>	80			
Pulsed Drain Current		I <sub>DM</sub>	200	A		
Continuous Source Current (Diode Conduction) <sup>a</sup>		IS	65			
Mandanian Danian Disabatian	T <sub>C</sub> = 25°C		71	w		
Maximum Power Dissipation	T <sub>A</sub> = 25°C	P <sub>D</sub>	8.3 <sup>b, c</sup>			
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	-55 to 175	°C		

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
	t ≤ 10 sec.	R <sub>thJA</sub>	15	18	°C/W		
Maximum Junction-to-Ambient <sup>b</sup>	Steady State		40	50			
Maximum Junction-to-Case	•	R <sub>thJC</sub>	1.75	2.1			

### Notes

- a. Package Limited
- b. Surface Mounted on 1" x 1" FR4 Board
- $c. \quad t \leq 10 \ \text{sec}$

服务热线:400-655-8788

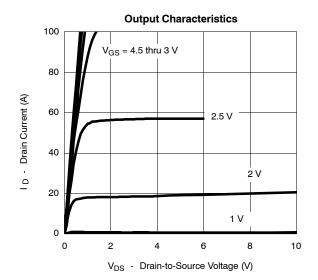


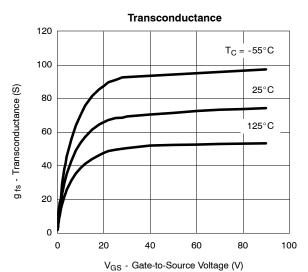
Parameter	Symbol	Test Condition	Min	Typ <sup>a</sup>	Max	Unit	
Static	1		<b>'</b>	•		•	
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{GS}$ = 0 V, $I_D$ = 250 $\mu A$	20			V	
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \mu A$	0.5		1.5	- v	
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 12 \text{ V}$			±100	nA	
		V <sub>DS</sub> = 20 V, V <sub>GS</sub> = 0 V			1	<u> </u>	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS}$ = 20 V, $V_{GS}$ = 0 V, $T_{J}$ = 125°C			50	μΑ	
On-State Drain Current <sup>b</sup>	I <sub>D(on)</sub>	$V_{DS} = 5 \text{ V}, V_{GS} = 4.5 \text{ V}$	100			Α	
		$V_{GS} = 4.5 \text{ V}, I_D = 20 \text{ A}$	0.004		I		
Drain-Source On-State Resistance <sup>b</sup>	r <sub>DS(on)</sub>	$V_{GS} = 4.5 \text{ V}, I_D = 20 \text{ A}, T_J = 125 ^{\circ}\text{C}$		0.0055		Ω	
		$V_{GS} = 2.5 \text{ V}, I_D = 20 \text{ A}$	0.006				
Forward Transconductanceb	9fs	$V_{DS} = 5 \text{ V}, I_{D} = 40 \text{ A}$	20			S	
Dynamic <sup>a</sup> Input Capacitance	C <sub>iss</sub>			3660		pF	
Output Capacitance	C <sub>oss</sub>	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 20 V, f = 1 MHz		730			
Reverse Transfer Capacitance	C <sub>rss</sub>			375			
Total Gate Charge <sup>c</sup>	Qq			26	35		
Gate-Source Charge <sup>c</sup>	Q <sub>gs</sub>	$V_{DS} = 10 \text{ V}, \ V_{GS} = 4.5 \text{ V}, \ I_{D} = 40 \text{ A}$		5		nC	
Gate-Drain Charge <sup>c</sup>	Q <sub>gd</sub>			7		1	
Gate Resistance	R <sub>g</sub>		1		3.7	Ω	
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>			20	35		
Rise Time <sup>c</sup>	t <sub>r</sub>	$V_{DD}$ = 10 V, $R_L$ = 0.25 $\Omega$		120	190		
Turn-Off Delay Time <sup>c</sup>	t <sub>d(off)</sub>	$I_D \cong 40 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_G = 2.5 \Omega$		45	70	ns	
Fall Time <sup>c</sup>	t <sub>f</sub>			20	35		
Source-Drain Diode Ratings and	l Characteristi	c (T <sub>C</sub> = 25°C)		•		•	
Pulsed Current	I <sub>SM</sub>				100	А	
Diode Forward Voltage <sup>b</sup>	V <sub>SD</sub>	I <sub>F</sub> = 100 A, V <sub>GS</sub> = 0 V		1.2	1.5	V	
Source-Drain Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = 40 A, di/dt = 100 A/μs		35	70	ns	

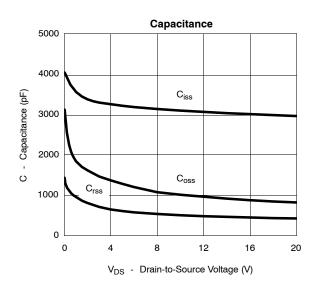
- Notes a. Guaranteed by design, not subject to production testing. b. Pulse test; pulse width  $\leq 300~\mu s$ , duty cycle  $\leq 2\%.$  c. Independent of operating temperature.

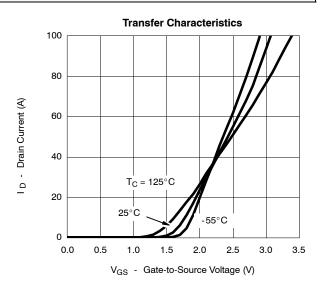


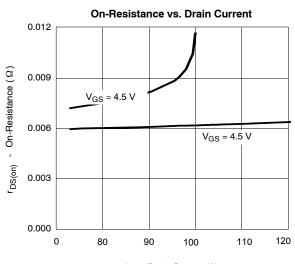
### TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)

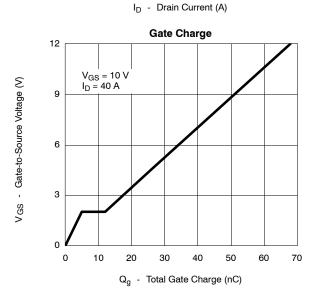






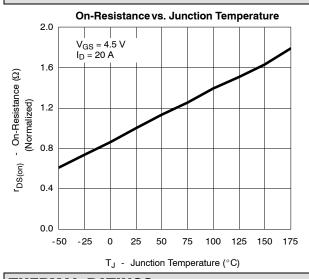


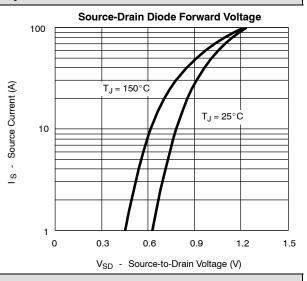




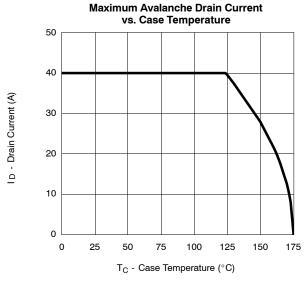


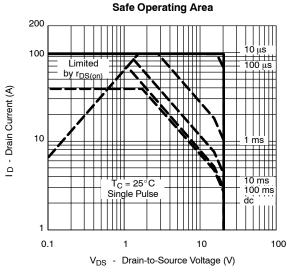
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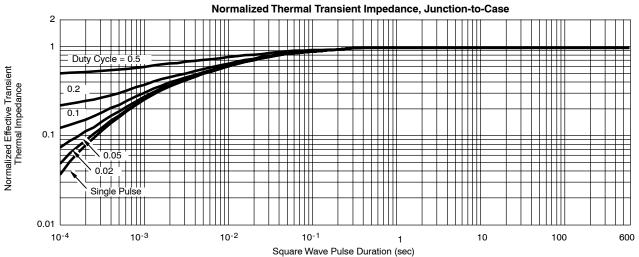




#### THERMAL RATINGS



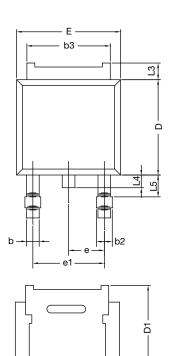


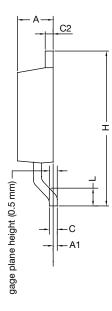


服务热线:400-655-8788



# **TO-252AA CASE OUTLINE**





	MILLIMETERS		INCHES			
DIM.	MIN.	MAX.	MIN.	MAX.		
Α	2.18	2.38	0.086	0.094		
A1	-	0.127	-	0.005		
b	0.64	0.88	0.025	0.035		
b2	0.76	1.14	0.030	0.045		
b3	4.95	5.46	0.195	0.215		
С	0.46	0.61	0.018	0.024		
C2	0.46	0.89	0.018	0.035		
D	5.97	6.22	0.235	0.245		
D1	5.21	-	0.205	-		
E	6.35	6.73	0.250	0.265		
E1	4.32	-	0.170	-		
Н	9.40	10.41	0.370	0.410		
е	2.28	BSC	0.090 BSC			
e1	4.56	BSC 0.180 B		4.56 BSC		BSC
L	1.40	1.78	0.055	0.070		
L3	0.89	1.27	0.035	0.050		
L4	=	1.02	=	0.040		
L5	1.14	1.52	0.045	0.060		
ECN: X12-0247-Rev. M, 24-Dec-12 DWG: 5347						

### Note

• Dimension L3 is for reference only.

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